



16-Bit, 10 MSPS ANALOG-TO-DIGITAL CONVERTER

FEATURES

- High-Speed, Wide Bandwidth $\Delta\Sigma$ ADC
- 10MSPS Output Data Rate
- 4.9MHz Signal Bandwidth
- 86dBFS Signal-to-Noise Ratio
- -94dB Total Harmonic Distortion
- 95dB Spurious-Free Dynamic Range
- On-Chip Digital Filter Simplifies Anti-Alias Requirements
- $\overline{\text{SYNC}}$ Pin for Simultaneous Sampling with Multiple ADS1610s
- Low 3 μ s Group Delay
- Parallel Interface
- Directly Connects to TMS320 DSPs
- Out-of-Range Alert Pin

APPLICATIONS

- Scientific Instruments
- Test Equipment
- Communications

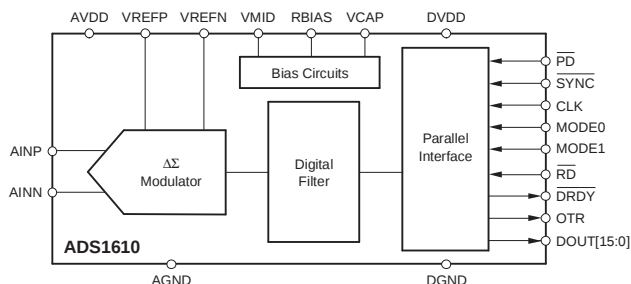
DESCRIPTION

The ADS1610 is a high-speed, high-precision, delta-sigma ($\Delta\Sigma$) analog-to-digital converter (ADC) with 16-bit resolution operating from a 5V analog and a 3V digital supply. Featuring an advanced multi-stage analog modulator combined with an on-chip digital decimation filter, the ADS1610 achieves 86 dBFS signal-to-noise ratio (SNR) in a 5MHz signal bandwidth; while the total harmonic distortion is -94dB.

The ADS1610 $\Delta\Sigma$ topology provides key system-level design advantages with respect to anti-alias filtering and clock jitter. The design of the user's front-end anti-alias filter is simplified since the on-chip digital filter greatly attenuates out-of-band signals. The ADS1610s filter has a *brick wall* response with a very flat passband (± 0.0002 dB of ripple) followed immediately by a very wide stop band (5MHz to 55MHz). Clock jitter becomes especially critical when digitizing high frequency, large-amplitude signals. The ADS1610 significantly reduces clock jitter sensitivity by an effective averaging of clock jitter as a result of oversampling the input signal.

Output data is supplied over a parallel interface and easily connects to TMS320 digital signal processors (DSPs). The power dissipation can be adjusted with an external resistor, allowing for reduction at lower operating speeds.

With its outstanding high-speed performance, the ADS1610 is well-suited for demanding applications in data acquisition, scientific instruments, test and measurement equipment, and communications. The ADS1610 is offered in a TQFP64 package and is specified from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ADS1610 passes 1.5K CDM testing. ADS1610 passes 1kV human body model testing (TI Standard is 2kV).

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

	VALUE	UNIT
AVDD to AGND	–0.3 to +6	V
DVDD to DGND	–0.3 to +3.6	V
AGND to DGND	–0.3 to +0.3	V
Input current, I_I	100, Momentary	mA
	10, Continuous	
Analog I/O to AGND	–0.3 to AVDD + 0.3	V
Digital I/O to DGND	–0.3 to DVDD + 0.3	V
Maximum junction temperature, T_J	150	°C
Operating free-air temperature range, T_A	–40 to +105	°C
Storage temperature range, T_{stg}	–60 to +150	°C
Lead temperature (soldering, 10s)	260	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

ELECTRICAL CHARACTERISTICS

All specifications at –40°C to 85°C, AVDD = 5V, DVDD = 3V, f_{CLK} = 60MHz, V_{REF} = 3V, MODE = 00, V_{CM} = 2.5V, and RBIAS = 19k Ω (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG INPUT						
$V_{ID(AINP - AINN)}$	Differential input voltage (AINP-AINN)			$\pm V_{REF}$		V
$V_{IC(AINP + AINN)/2}$	Common-mode input voltage			2.5		V
V_{IHA}	Absolute input voltage (AINP or AINN with respect to AGND)		–0.1		4.2	V
DYNAMIC SPECIFICATIONS						
Data rate				$10 \left(\frac{f_{CLK}}{60 \text{ MHz}} \right)$		MSPS
SNR	Signal-to-noise ration relative to full-scale ⁽¹⁾	$f_{IN} = 100\text{kHz}$, –2dBFS	83	86		dBFS

(1) For reference, this dynamic specification is extrapolated to full-scale and is thus dBFS. Subsequent dynamic specifications are dBc (dB), which is: Specification (in dBc) = Specification (in dBFS) + AIN (input amplitude in dBFS). For more information see [Understanding and comparing datasheets for high-speed ADCs](#).

ELECTRICAL CHARACTERISTICS (continued)

All specifications at -40°C to 85°C , $\text{AVDD} = 5\text{V}$, $\text{DVDD} = 3\text{V}$, $f_{\text{CLK}} = 60\text{MHz}$, $V_{\text{REF}} = 3\text{V}$, $\text{MODE} = 00$, $V_{\text{CM}} = 2.5\text{V}$, and $\text{RBIAS} = 19\text{k}\Omega$ (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SNR	Signal-to-noise ratio	f _{IN} = 100kHz, −2dBFS	81	84		dB
		f _{IN} = 100kHz, −6dBFS	77	80		
		f _{IN} = 100kHz, −20dBFS		66		
		f _{IN} = 1MHz, −2dBFS		83		
		f _{IN} = 1MHz, −6dBFS		80		
		f _{IN} = 1MHz, −20dBFS		66		
		f _{IN} = 4MHz, −2dBFS	79.5	83		
		f _{IN} = 4MHz, −6dBFS	76	79		
		f _{IN} = 4MHz, −20dBFS		65		
THD	Total harmonic distortion	f _{IN} = 100kHz, −2dBFS		−90	−83	dB
		f _{IN} = 100kHz, −6dBFS		−95	−85	
		f _{IN} = 100kHz, −20dBFS		−95		
		f _{IN} = 1MHz, −2dBFS		−91		
		f _{IN} = 1MHz, −6dBFS		−93		
		f _{IN} = 1MHz, −20dBFS		−95		
		f _{IN} = 4MHz, −2dBFS		−109	−100	
		f _{IN} = 4MHz, −6dBFS		−105	−100	
		f _{IN} = 4MHz, −20dBFS		−95		
SINAD	Signal-to-noise and distortion	f _{IN} = 100kHz, −2dBFS		83		dB
		f _{IN} = 100kHz, −6dBFS		79		
		f _{IN} = 100kHz, −20dBFS		65		
		f _{IN} = 1MHz, −2dBFS		82		
		f _{IN} = 1MHz, −6dBFS		79		
		f _{IN} = 1MHz, −20dBFS		65		
		f _{IN} = 4MHz, −2dBFS		83		
		f _{IN} = 4MHz, −6dBFS		79		
		f _{IN} = 4MHz, −20dBFS		65		
SFDR	Spurious-free dynamic range	f _{IN} = 100kHz, −2dBFS	85	90		dB
		f _{IN} = 100kHz, −6dBFS	90	96		
		f _{IN} = 100kHz, −20dBFS		96		
		f _{IN} = 1MHz, −2dBFS		94		
		f _{IN} = 1MHz, −6dBFS		94		
		f _{IN} = 1MHz, −20 dBFS		96		
		f _{IN} = 4MHz, −2dBFS	100	109		
		f _{IN} = 4MHz, −6dBFS	100	105		
		f _{IN} = 4MHz, −20dBFS		95		
Aperture jitter		Excludes jitter of CLK source		2		ps, rms
Aperture delay				4		ns

ELECTRICAL CHARACTERISTICS (Continued)

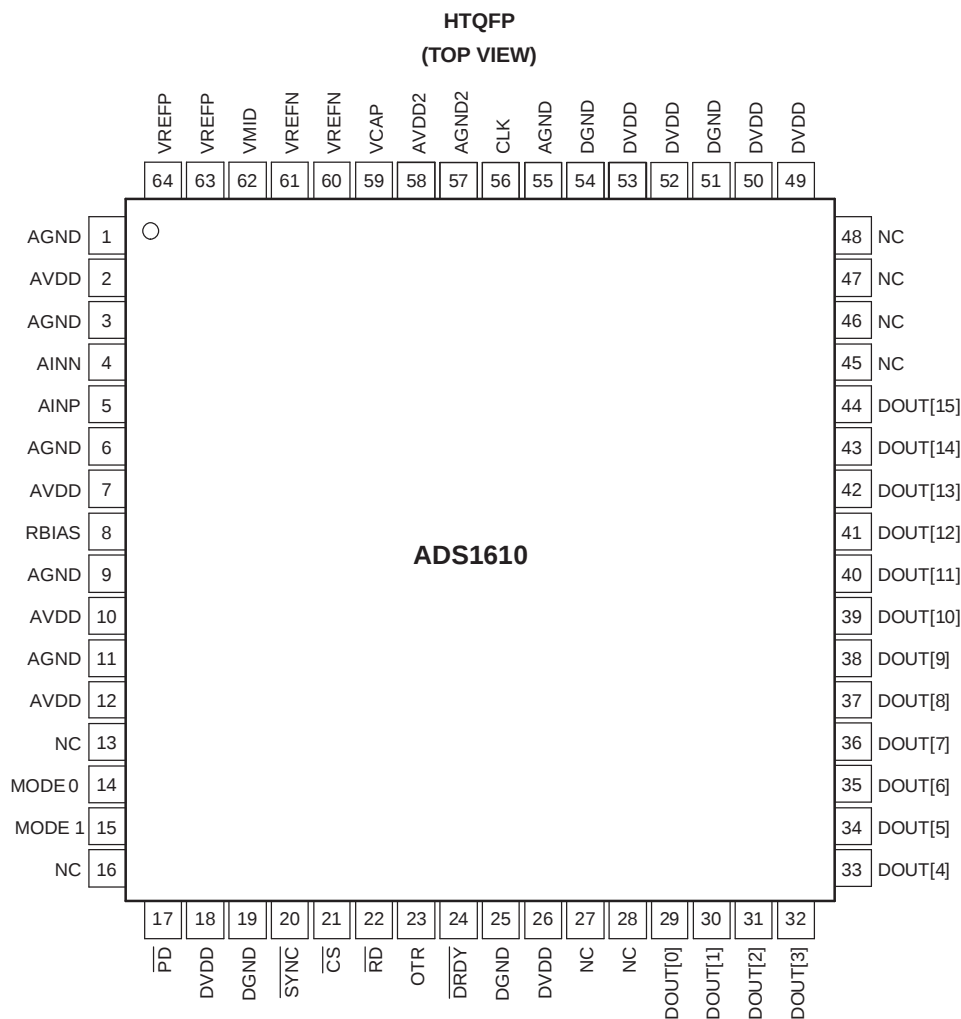
All specifications at –40°C to 85°C, AVDD = 5V, DVDD = 3V, f_{CLK} = 60MHz, V_{REF} = 3V, MODE = 00, V_{CM} = 2.5V, and R_{BIAS} = 19kΩ (unless otherwise noted).

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DIGITAL FILTER CHARACTERISTICS					
Passband		0		$4.4 \left(\frac{f_{CLK}}{60 \text{ MHz}} \right)$	MHz
Passband ripple				±0.0002	dB
Passband transition	–0.1dB attenuation		$4.6 \left(\frac{f_{CLK}}{60 \text{ MHz}} \right)$		MHz
	–3.0dB attenuation		$4.9 \left(\frac{f_{CLK}}{60 \text{ MHz}} \right)$		
Stop band		5.6		54.4	MHz
Stop band attenuation		80	See Figure 34		dB
t _{d(grp)} Group delay			$3.0 \left(\frac{60 \text{ MHz}}{f_{CLK}} \right)$		μs
t _s Settling time	To ±0.001%		$5.5 \left(\frac{60 \text{ MHz}}{f_{CLK}} \right)$		μs
STATIC SPECIFICATIONS					
Resolution	No missing codes	16			Bits
Input rms noise	Shorted input		1.0	1.4	LSB (rms)
Integral nonlinearity	1V input		±0.4		LSB
	2.5V input		±1.5		LSB
Differential nonlinearity			±0.5		LSB
V _{IO} Offset error	T = 25°C		0.05		%FS
Offset drift			5		ppm/°C
G _(ERR) Gain error	T = 25°C		±0.3 ⁽¹⁾		%FS
G Gain drift	Excluding reference drift		10		ppm/°C
CMRR Common-mode rejection ratio	At DC		60		dB
PSRR Supply-voltage rejection ratio	At DC		80		dB
VOLTAGE REFERENCE					
V _{ref} Reference voltage, (VREFP - VREFN)		2.9	3.0	3.1	V
VREFP		3.6	4.0	4.4	V
VREFN		0.9	1.0	1.1	V
VMID		2.2	2.5	3.8	V
DIGITAL INPUT/OUTPUT					
V _{IH} High-level input voltage		0.7DVDD		DVDD	V
V _{IL} Low-level input voltage		DGND		0.3DVDD	V
V _{OH} High-level output voltage	I _{OH} = –50μA	0.8DVDD			V
V _{OL} Low-level output voltage	I _{OL} = 50μA			0.2DVDD	V
I _{ikg} Input leakage current	DGND < V _{DIGITAL INPUT} < DVDD			±10	μA
POWER-SUPPLY REQUIREMENTS					
V _{AVDD} AVDD voltage		4.9	5.0	5.1	V
V _{DVDD} DVDD voltage		2.7	3.0	3.6	V
I _{AVDD} AVDD current			150	170	mA
I _{DVDD} DVDD current			70	80	mA
P _D Power dissipation			960	1100	mW
	$\overline{\text{PD}}$ = low		4		

(1) There is a constant gain error of 3.8% in addition to the variable gain error of ±0.3%. Therefore, the gain error is 3.8 ±0.3%.

DEVICE INFORMATION

PIN CONFIGURATION

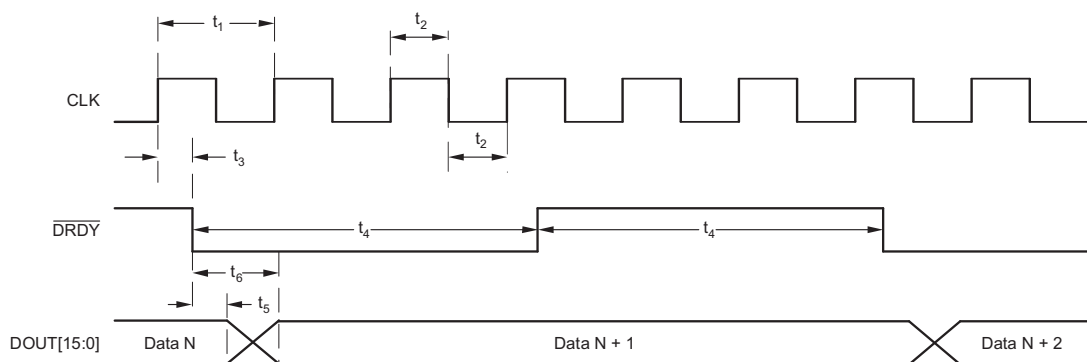
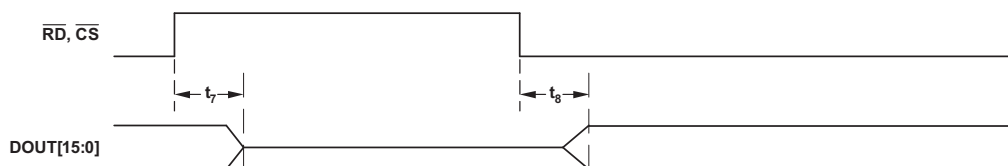


TERMINAL FUNCTIONS

TERMINAL		ANALOG/DIGITAL INPUT/OUTPUT	DESCRIPTION
NAME	NO.		
AGND	1, 3, 6, 9, 11, 55	Analog	Analog ground
AVDD	2, 7, 10, 12	Analog	Analog supply
AINN	4	Analog input	Negative analog input
AINP	5	Analog input	Positive analog input
RBIAS	8	Analog	Analog bias setting resistor
NC	13, 16, 27, 28, 45–48	—	Must be left unconnected.
MODE	14, 15	Digital input	Control for four output modes (See <i>MODE SELECTION</i> section)
$\overline{\text{PD}}$	17	Digital input; active low	Power-down
DVDD	18, 26, 49, 50, 52, 53	Digital	Digital supply
DGND	19, 25, 51, 54	Digital	Digital ground
$\overline{\text{SYNC}}$	20	Digital input; active low	Digital reset
$\overline{\text{CS}}$	21	Digital input; active low	Chip-select

TERMINAL FUNCTIONS (continued)

TERMINAL		ANALOG/DIGITAL INPUT/OUTPUT	DESCRIPTION
NAME	NO.		
$\overline{\text{RD}}$	22	Digital input; Active low	Read enable
OTR	23	Digital output	Analog inputs out-of-range
$\overline{\text{DRDY}}$	24	Digital output	Data ready
DOUT[15:0]	29–44	Digital output	Data output. DOUT[15] is the MSB and DOUT[0] is the LSB.
CLK	56	Digital input	Clock input
AGND2	57	Analog	Analog ground for AVDD2
AVDD2	58	Analog	Analog supply for modulator clocking
VCAP	59	Analog	Bypass capacitor
VREFN	60, 61	Analog	Negative reference voltage
VMID	62	Analog	Midpoint voltage
VREFP	63, 64	Analog	Positive reference voltage

TIMING SPECIFICATIONS**Figure 1. Data Retrieval Timing****Figure 2. DOUT Inactive/Active Timing**

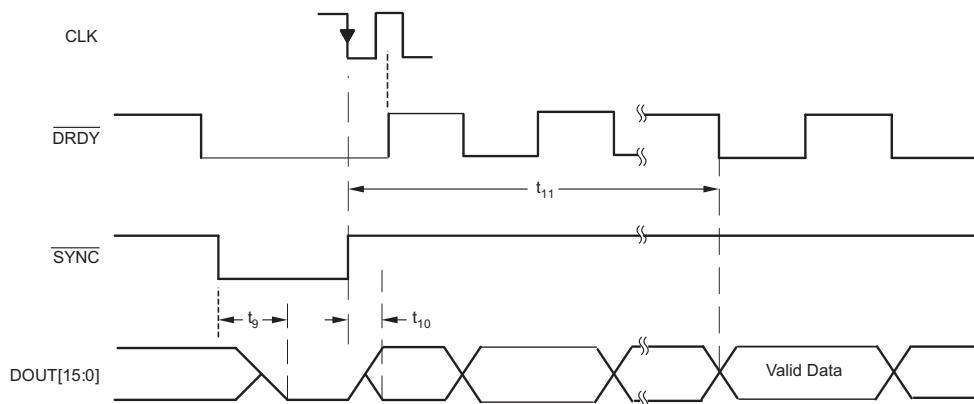


Figure 3. Reset Timing

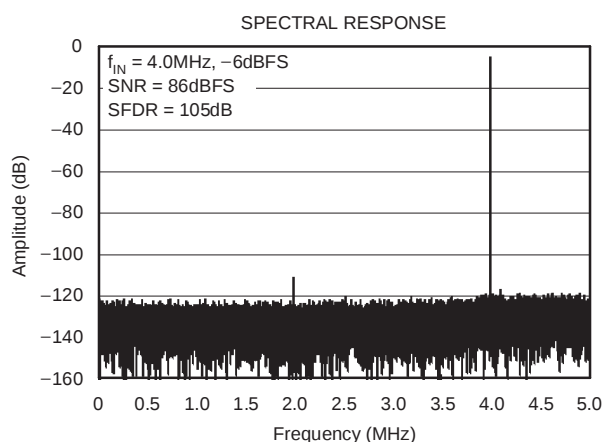
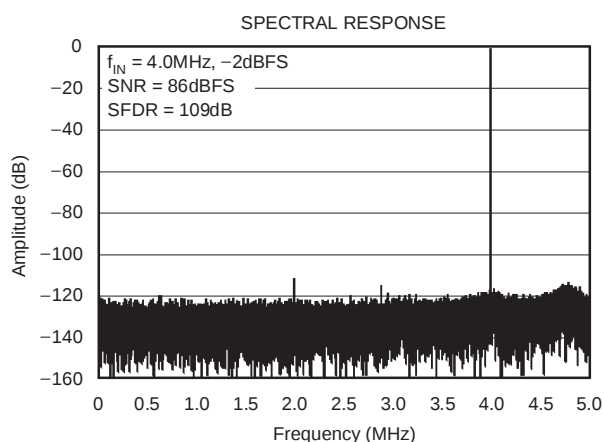
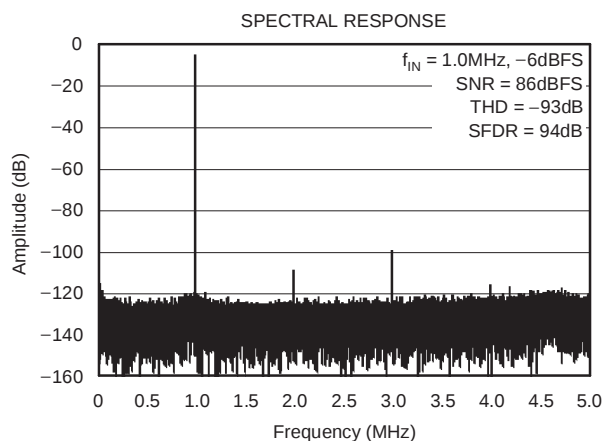
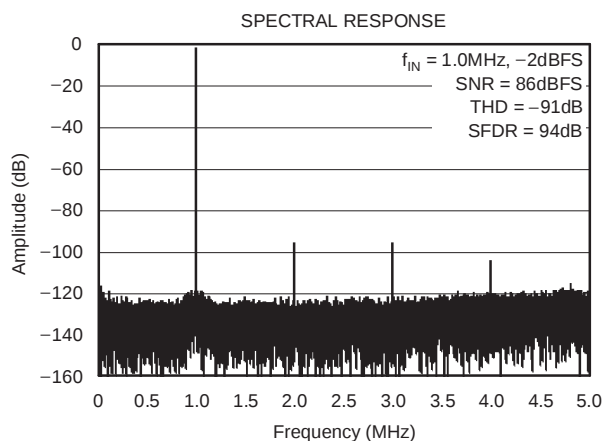
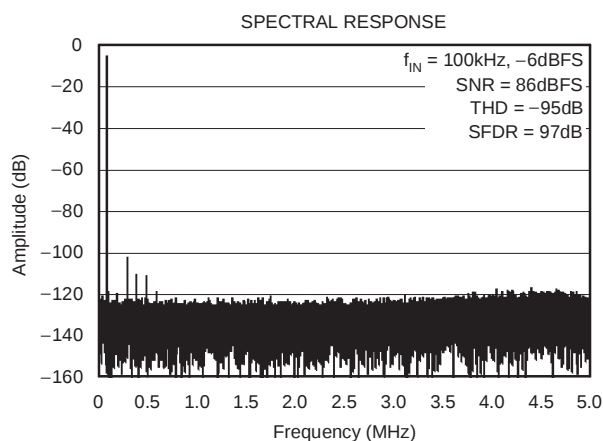
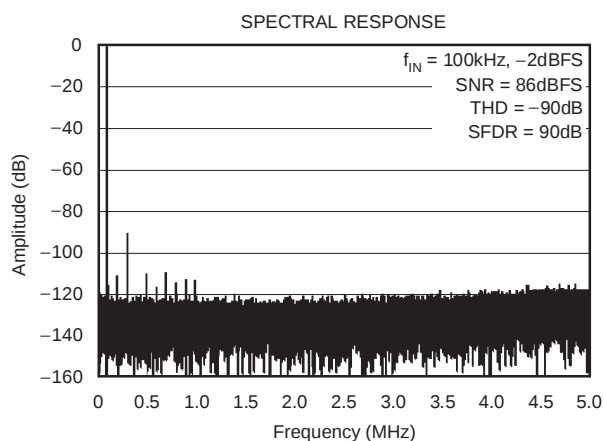
Timing Specifications⁽¹⁾

	DESCRIPTION	MIN	TYP	MAX	UNIT
t_1	CLK period ($1/f_{CLK}$)	16.667			ns
$1/t_1$	f_{CLK}	1		60	MHz
t_2	CLK pulse width, high or low	45%		55%	ns
t_3	CLK to $\overline{DRDY}$ high (propagation delay)		12		ns
t_4	$\overline{DRDY}$ pulse width, high or low		$3 t_1$		ns
t_5	Previous data valid (hold time)	0			ns
t_6	New data valid (setup time)			5	ns
t_7	$\overline{RD}$ and/or $\overline{CS}$ inactive (high) to DOUT high impedance		15		ns
t_8	$\overline{RD}$ and/or $\overline{CS}$ active (low) to DOUT active		15		ns
t_9	Delay from $\overline{SYNC}$ active (low) to all-zero DOUT[15:0]		12		ns
t_{10}	Delay from $\overline{SYNC}$ inactive (high) to non-zero DOUT[15:0]			21	DRDY
t_{11}	Delay from $\overline{SYNC}$ inactive (high) to valid DOUT[15:0] (time – 55 $\overline{DRDY}$ cycles; required for digital filter to settle).		55		DRDY

(1) Output load = 10pF|| 500kΩ.

TYPICAL CHARACTERISTICS

At $T_A = 25^\circ\text{C}$, $R_{\text{BIAS}} = 19\text{k}\Omega$, $\text{AVDD} = 5\text{V}$, $\text{DVDD} = 3\text{V}$, $f_{\text{CLK}} = 60\text{MHz}$, $V_{\text{REF}} = 3\text{V}$, $\text{MODE} = 00$, and $V_{\text{CM}} = 2.5\text{V}$ (unless otherwise noted).



TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $R_{\text{BIAS}} = 19\text{k}\Omega$, $\text{AVDD} = 5\text{V}$, $\text{DVDD} = 3\text{V}$, $f_{\text{CLK}} = 60\text{MHz}$, $V_{\text{REF}} = 3\text{V}$, $\text{MODE} = 00$, and $V_{\text{CM}} = 2.5\text{V}$ (unless otherwise noted).

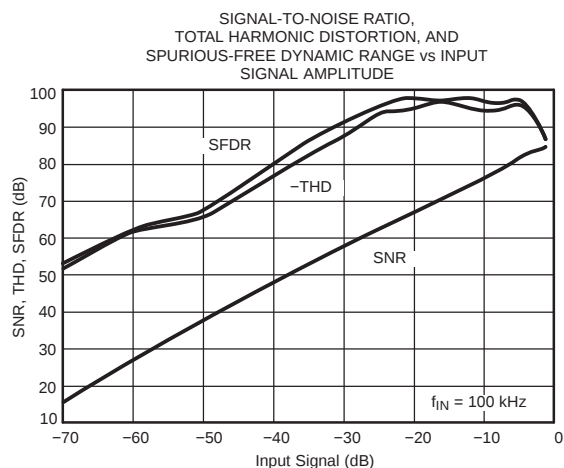


Figure 10.

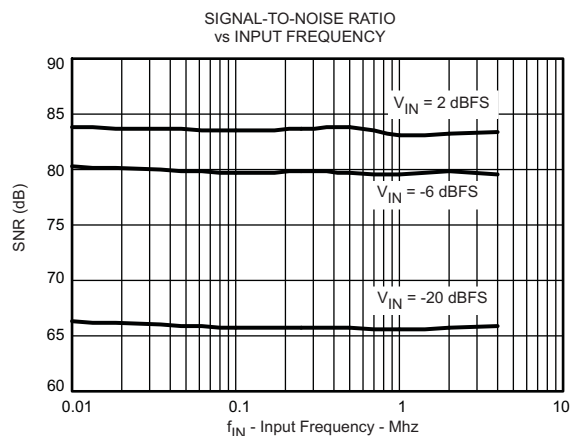


Figure 11.

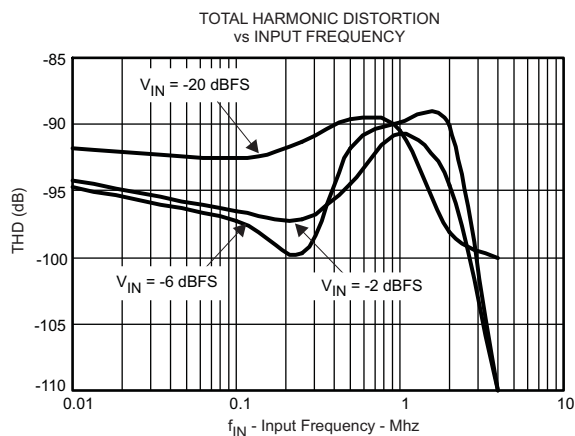


Figure 12.

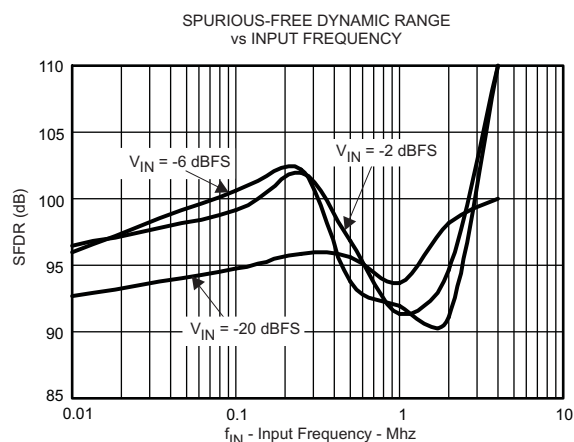


Figure 13.

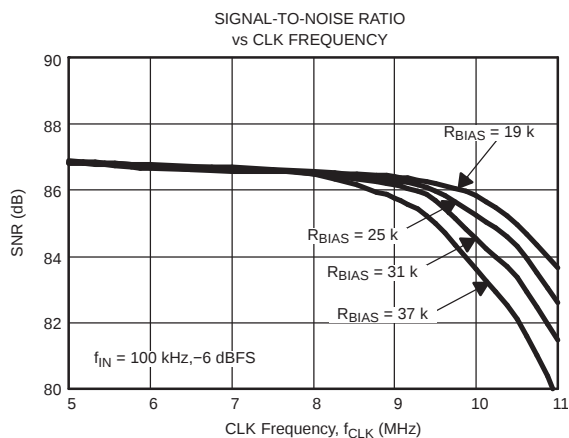


Figure 14.

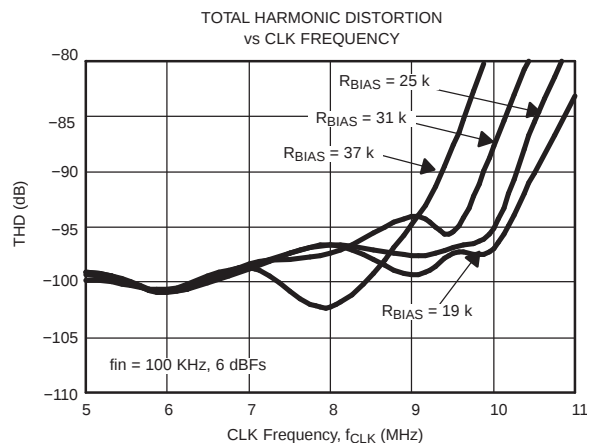


Figure 15.

TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $R_{\text{BIAS}} = 19\text{k}\Omega$, $\text{AVDD} = 5\text{V}$, $\text{DVDD} = 3\text{V}$, $f_{\text{CLK}} = 60\text{MHz}$, $V_{\text{REF}} = 3\text{V}$, $\text{MODE} = 00$, and $V_{\text{CM}} = 2.5\text{V}$ (unless otherwise noted).

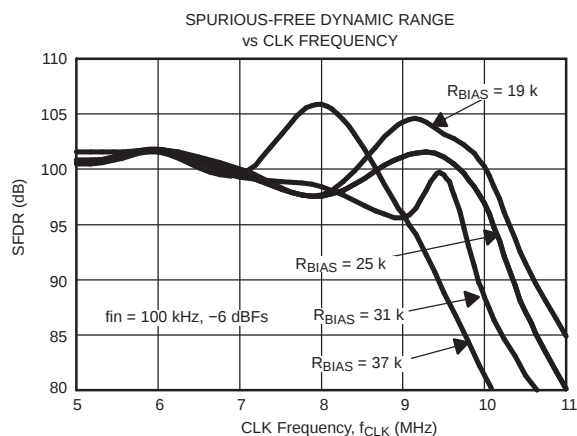


Figure 16.

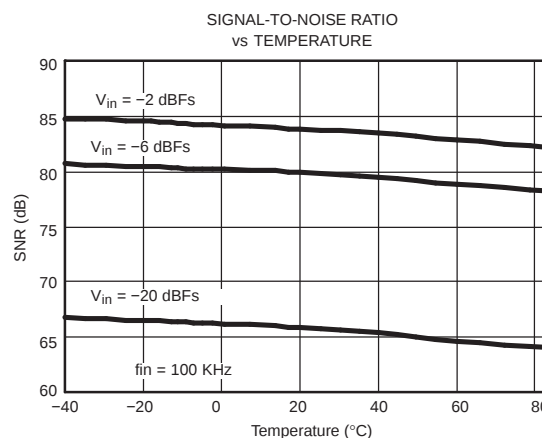


Figure 17.

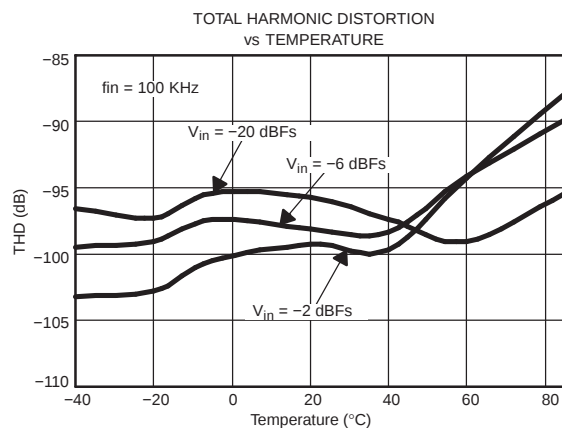


Figure 18.

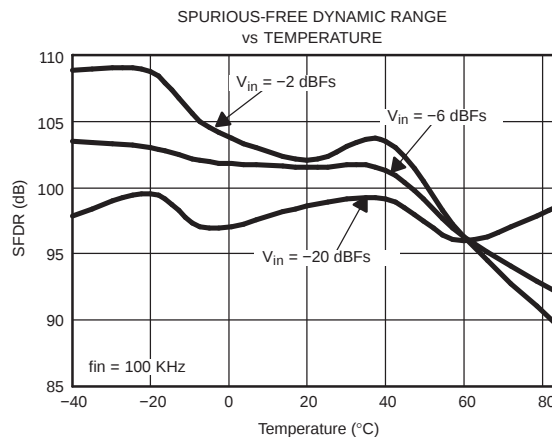


Figure 19.

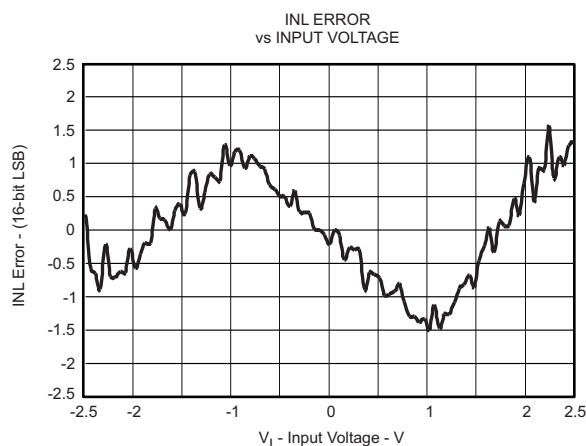


Figure 20.

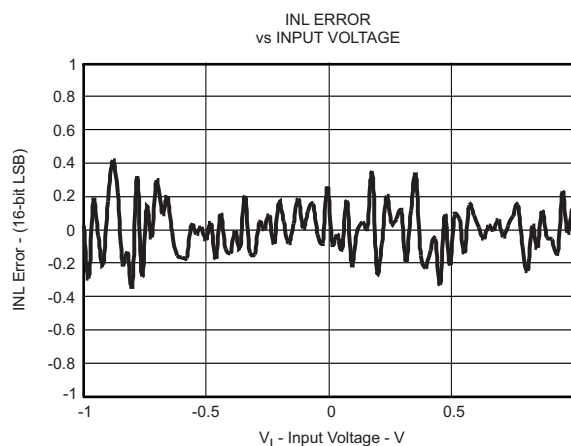


Figure 21.

TYPICAL CHARACTERISTICS (continued)

At $T_A = 25^\circ\text{C}$, $R_{\text{BIAS}} = 19\text{k}\Omega$, $\text{AVDD} = 5\text{V}$, $\text{DVDD} = 3\text{V}$, $f_{\text{CLK}} = 60\text{MHz}$, $V_{\text{REF}} = 3\text{V}$, $\text{MODE} = 00$, and $V_{\text{CM}} = 2.5\text{V}$ (unless otherwise noted).

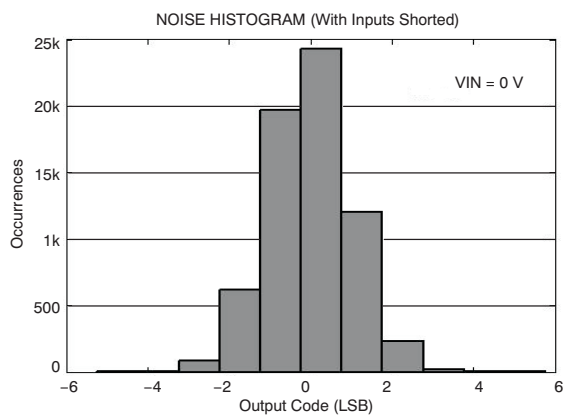


Figure 22.

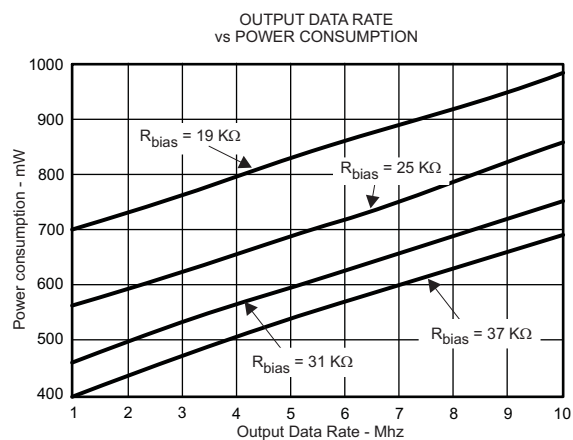


Figure 23.

OVERVIEW

The ADS1610 is a high-performance, delta-sigma ADC. The modulator uses an inherently stable, pipelined, delta-sigma modulator architecture incorporating proprietary circuitry that allows for very linear high-speed operation. The modulator samples the input signal at 60MSPS (when $f_{CLK} = 60\text{MHz}$). A low-ripple linear phase digital filter decimates the modulator output by 6 to provide data output word rates of 10MSPS with a signal passband out to 4.9MHz.

Conceptually, the modulator and digital filter measure the differential input signal, $V_{ID} = (A_{INP} - A_{INN})$, against the differential reference, $V_{ref} = (V_{REFP} - V_{REFN})$, as shown in Figure 11. A 16-bit parallel data bus, designed for direct connection to DSPs, outputs the data. A separate power supply for the I/O allows flexibility for interfacing to different logic families. Out-of-range conditions are indicated with a dedicated digital output pin. Analog power dissipation is controlled using an external resistor. This allows reduced dissipation when operating at slower speeds. When not in use, power consumption can be dramatically reduced using the PD pin.

ANALOG INPUTS (A_{INP}, A_{INN})

The ADS1610 supports a very wide range of input signals. Having such a wide input range makes out-of-range signals unlikely. However, should an out-of-range signal occur, the digital output OTR will go high.

To achieve the highest analog performance, it is recommended that the inputs be limited to no greater than $0.891V_{REF}$ (-1dBFS). For $V_{REF} = 3\text{V}$, the corresponding recommended input range is 2.67V.

The analog inputs must be driven with a differential signal to achieve optimum performance. The recommended common-mode voltage of the input signal, $V_{CM} = \frac{A_{INP} + A_{INN}}{2}$ is 2.5V.

In addition to the differential and common-mode input voltages, the absolute input voltage is also important. This is the voltage on either input (A_{INP} or A_{INN}) with respect to AGND. The range for this voltage is:

$$-0.1\text{ V} < (A_{INN} \text{ or } A_{INP}) < 4.2\text{ V} \quad (1)$$

If either input is taken below -0.1V , ESD protection diodes on the inputs will turn on. Exceeding 4.2V on either input will result in linearity performance degradation. ESD protection diodes will also turn on if the inputs are taken above AVDD (+5V).

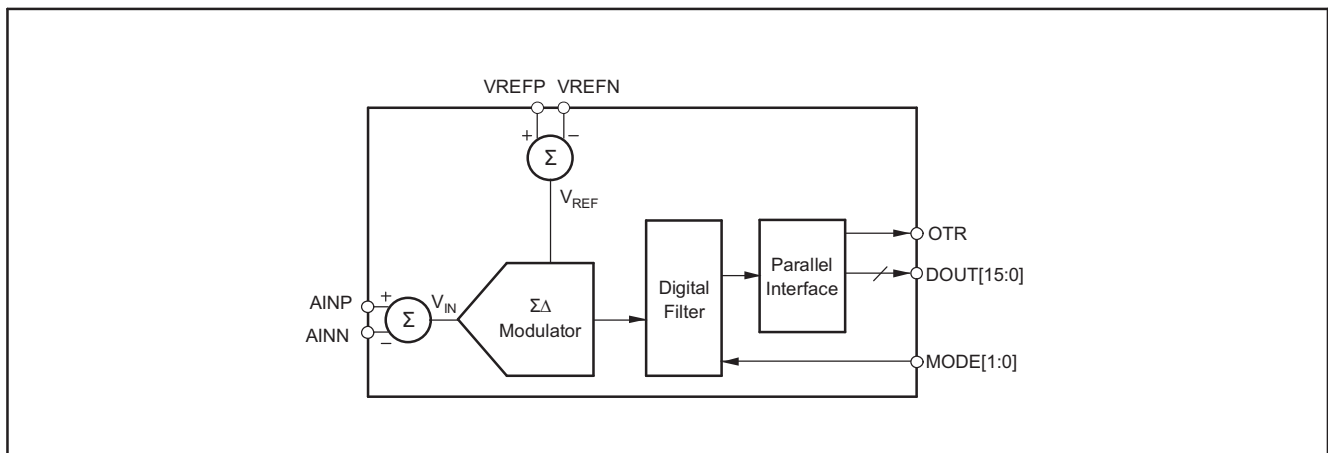


Figure 24. Conceptual Block Diagram

INPUT CIRCUITRY

The ADS1610 uses switched-capacitor circuitry to measure the input voltage. Internal capacitors are charged by the inputs and then discharged internally with this cycle repeating at the frequency of CLK. Figure 25 shows a conceptual diagram of these

circuits. Switches S_2 represent the net effect of the modulator circuitry in discharging the sampling capacitors, the actual implementation is different. The timing for switches S_1 and S_2 is shown in Figure 26.

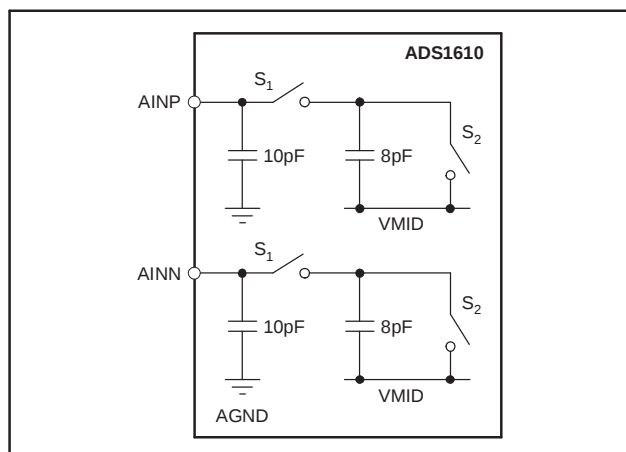


Figure 25. Conceptual Diagram of Internal Circuitry Connected to the Analog Inputs

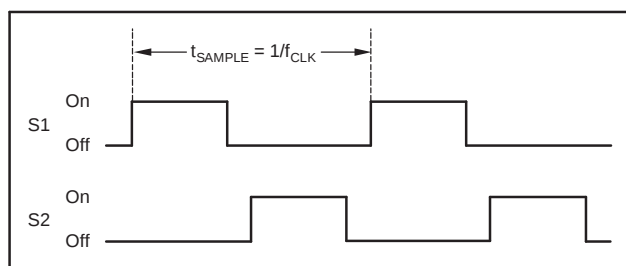


Figure 26. Timing for the Switches in Figure 25

DRIVING THE INPUTS

The external circuits driving the ADS1610 inputs must be able to handle the load presented by the switching capacitors within the ADS1610. The input switches S_1 in Figure 25 are closed approximately one half of the sampling period, t_{SAMPLE} , allowing only ~ 8 ns for the internal capacitors to be charged by the inputs, when $f_{\text{CLK}} = 60$ MHz.

Figure 27 and Figure 28 show the recommended circuits when using single-ended or differential op amps, respectively. The analog inputs must be driven differentially to achieve optimum performance. If only a single-ended input signal is available, the configuration in Figure 27 can be used by shorting $-V_{\text{IN}}$ to ground.

This configuration would implement the single-ended to differential conversion.

The external capacitors, between the inputs and from each input to AGND, improve linearity and should be placed as close to the pins as possible. Place the drivers close to the inputs and use good capacitor bypass techniques on their supplies; usually a smaller high-quality ceramic capacitor in parallel with a larger capacitor. Keep the resistances used in the

driver circuits low-thermal noise in the driver circuits degrades the overall noise performance. When the signal can be AC-coupled to the ADS1610 inputs, a simple RC filter can set the input common mode voltage. The ADS1610 is a high-speed, high-performance ADC. Special care must be taken when selecting the test equipment and setup used with this device. Pay particular attention to the signal sources to ensure they do not limit performance when measuring the ADS1610.

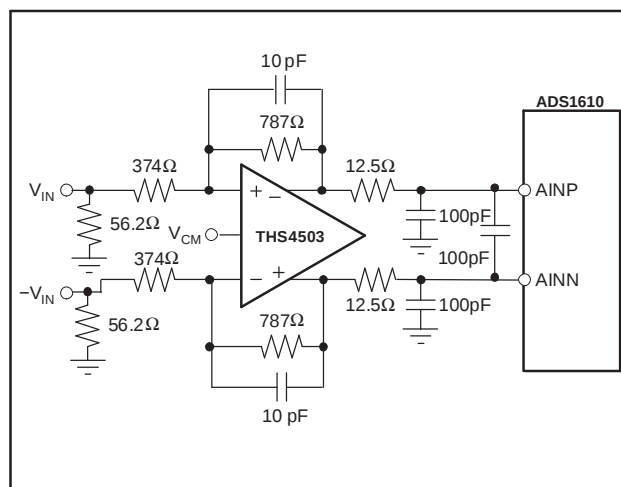
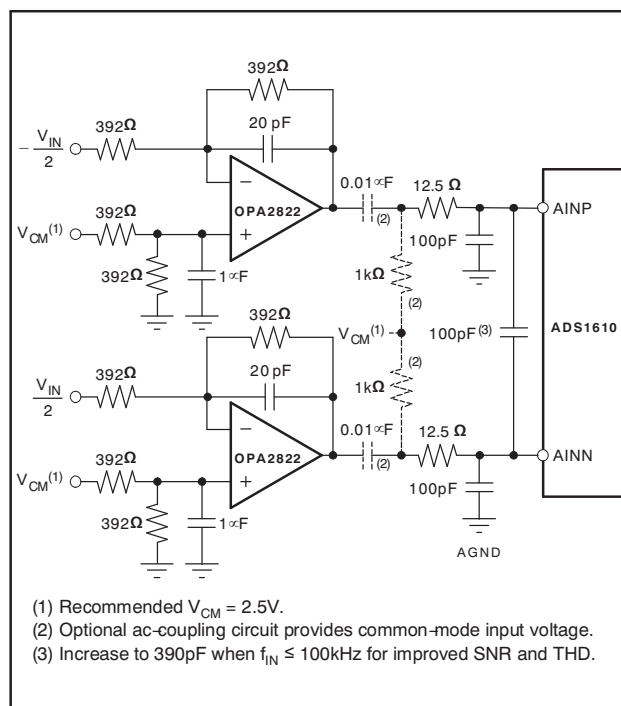


Figure 27. Recommended Single-Ended to Differential Conversion Circuit Using the THS4503 Differential Amplifier



- (1) Recommended $V_{\text{CM}} = 2.5$ V.
- (2) Optional ac-coupling circuit provides common-mode input voltage.
- (3) Increase to 390pF when $f_{\text{IN}} \leq 100$ kHz for improved SNR and THD.

Figure 28. Recommended Driver Circuit Using the OPA2822

REFERENCE INPUTS (VREFN, VREFP, VMID)

The ADS1610 operates from an external voltage reference. The reference voltage (V_{ref}) is set by the differential voltage between VREFN and VREFP: $V_{ref} = (VREFP - VREFN)$. VREFP and VREFN each use two pins, which should be shorted together. VMID, approximately 2.5V, is used by the modulator. VCAP connects to an internal node and must also be be bypassed with an external capacitor.

The voltages applied to these pins must be within the values specified in the Electrical Characteristics table. Typically $VREFP = 4V$, $VMID = 2.5V$, and $VREFN = 1V$. The external circuitry must be capable of providing both a DC and a transient current. Figure 29 shows a simplified diagram of the internal circuitry of the reference. As with the input circuitry, switches S_1 and S_2 open and close as shown in Figure 26.

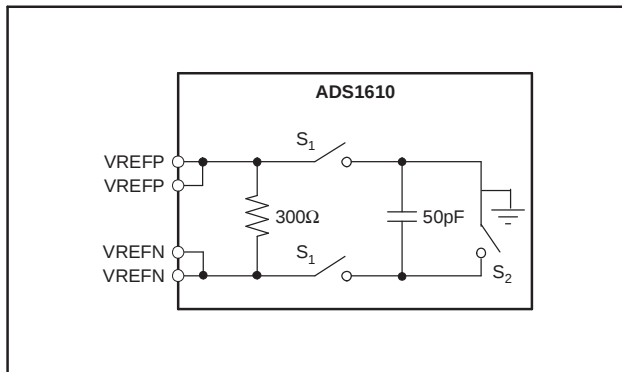


Figure 29. Conceptual Circuitry for the Reference Inputs

Figure 30 shows the recommended circuitry for driving these reference inputs. Keep the resistances used in the buffer circuits low to prevent excessive thermal noise from degrading performance. Layout of these circuits is critical, make sure to follow good high-speed layout practices. Place the buffers and especially the bypass capacitors as close to the pins as possible.

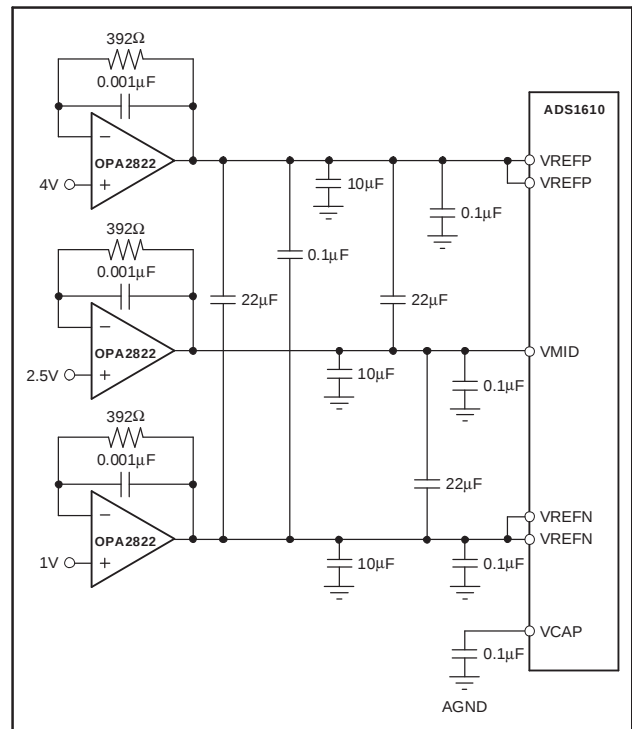


Figure 30. Recommended Reference Buffer Circuit

CLOCK INPUT (CLK)

The ADS1610 uses an external clock signal to be applied to the CLK input pin. The sampling of the modulator is controlled by this clock signal. As with any high-speed data converter, a high quality clock is essential for optimum performance. Crystal clock oscillators are the recommended CLK source; other sources, such as frequency synthesizers may not be adequate. Make sure to avoid excess ringing on the CLK input; keeping the trace as short as possible will help.

Measuring high-frequency, large-amplitude signals requires tight control of clock jitter. The uncertainty during sampling of the input from clock jitter limits the maximum achievable SNR. This effect becomes more pronounced with higher frequency and larger magnitude inputs. The ADS1610 oversampling topology reduces clock jitter sensitivity over that of Nyquist rate converters like pipeline and successive approximation converters by a factor of $\sqrt{6}$.

In order to not limit the ADS1610 SNR performance, keep the jitter on the clock source below the values shown in Table 1. When measuring lower frequency and lower amplitude inputs, more CLK jitter can be tolerated. In determining the allowable clock source jitter, select the worst-case input (highest frequency, largest amplitude) that will be seen in the application.

DATA FORMAT

The 16-bit output data is in binary two's complement format, as shown in Table 2. When the input is positive out-of-range, exceeding the positive full-scale value of V_{REF} , the output clips to all 7FFF_H and the OTR output goes high.

Table 1. Maximum Allowable Clock Source Jitter for Different Input Signal Frequencies and Amplitude

INPUT SIGNAL		MAXIMUM ALLOWABLE CLOCK SOURCE JITTER
MAXIMUM FREQUENCY	MAXIMUM AMPLITUDE	
4MHz	–1dB	1.6ps
4MHz	–20dB	14ps
2MHz	–1dB	3.3ps
2MHz	–20dB	29ps
1MHz	–1dB	6.5ps
1MHz	–20dB	58ps
100kHz	–1dB	65ps
100kHz	–20dB	581ps

Table 2. Output Code Versus Input Signal

INPUT SIGNAL (INP – INN)	IDEAL OUTPUT CODE ⁽¹⁾	OTR
$\geq +V_{ref}$ (> 0dB)	7FFF _H	1
V_{ref} (0dB)	7FFF _H	0
$\frac{+V_{REF}}{2^{15} - 1}$	0001 _H	0
0	0000 _H	0
$\frac{-V_{REF}}{2^{15} - 1}$	FFFF _H	0
$-V_{REF}\left(\frac{2^{15}}{2^{15} - 1}\right)$	8000 _H	0
$\leq -V_{REF}\left(\frac{2^{15}}{2^{15} - 1}\right)$	8000 _H	1

⁽¹⁾Excludes effects of noise, INL, offset and gain errors.

Likewise, when the input is negative out-of-range by going below the negative full-scale value of V_{ref} , the output clips to 8000_H and the OTR output goes high. The OTR remains high while the input signal is out-of-range.

OUT-OF-RANGE INDICATION (OTR)

If the output code on DOUT[15:0] exceeds the positive or negative full-scale, the out-of-range digital output (OTR) will go high on the falling edge of $\overline{DRDY}$. When the output code returns within the full-scale range, OTR returns low on the falling edge of $\overline{DRDY}$.

DATA RETRIEVAL

Data retrieval is controlled through a simple parallel interface. The falling edge of the $\overline{DRDY}$ output indicates new data is available. To activate the output bus, both $\overline{CS}$ and $\overline{RD}$ must be low, as shown in Table 3. Make sure the DOUT bus does not drive heavy loads (> 20pF), as this will degrade performance. Use an external buffer when driving an edge connector or cables.

Table 3. Truth Table for $\overline{CS}$ and $\overline{RD}$

$\overline{CS}$	$\overline{RD}$	DOUT [15:0]
0	0	Active
0	1	High impedance
1	0	High impedance
1	1	High impedance

SYNCHRONISING MULTIPLE ADS1610s

The ADS1610 is asynchronously reset when the $\overline{SYNC}$ pin is taken low. During reset, all of the digital circuits are cleared, DOUT[15:0] are forced low, and $\overline{DRDY}$ forced high. It is recommended that the $\overline{SYNC}$ pin be released on the falling edge of CLK. Afterwards, $\overline{DRDY}$ goes low on the second rising edge of CLK. Allow 55 $\overline{DRDY}$ cycles for the digital filter to settle before retrieving data. See Figure 3 for the timing specifications.

Reset can be used to synchronize multiple ADS1610s. All devices to be synchronized must use a common CLK input. With the CLK inputs running, pulse $\overline{SYNC}$ on the falling edge of CLK, as shown in Figure 31. Afterwards, the converters will be converting synchronously with the $\overline{DRDY}$ outputs updating simultaneously. After synchronization, allow 55 $\overline{DRDY}$ cycles (t_{11}) for output data to fully settle.

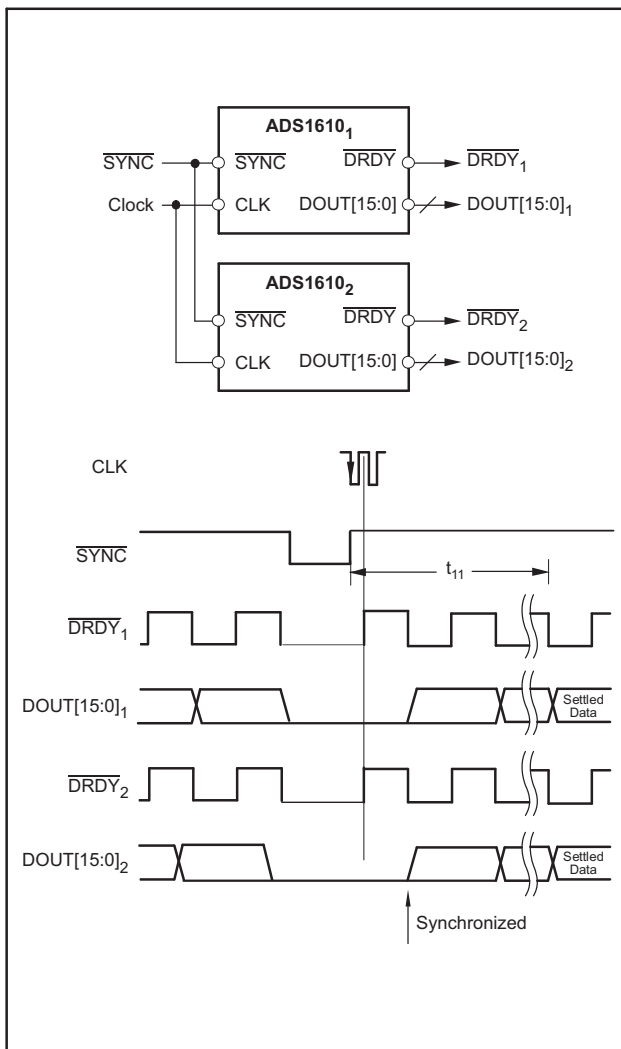


Figure 31. Synchronizing Multiple Converters

SETTLING TIME

The settling time is an important consideration when measuring signals with large steps or when using a multiplexer in front of the analog inputs. The ADS1610 digital filter requires time for an instantaneous change in signal level to propagate to the output.

Be sure to allow the filter time to settle after applying a large step in the input signal, switching the channel on a multiplexer placed in front of the inputs, resetting the ADS1610, or exiting the power-down mode.

Figure 32 shows the settling error as a function of time for a full-scale signal step applied at $t = 0$, with $\text{MODE} = 00$ (See Table 4). This figure uses $\overline{\text{DRDY}}$ cycles for the ADS1610 for the time scale (X-axis). After 55 $\overline{\text{DRDY}}$ cycles, the settling error drops below 0.001%. For $f_{\text{CLK}} = 60\text{MHz}$, this corresponds to a settling time of $5.5\mu\text{s}$.

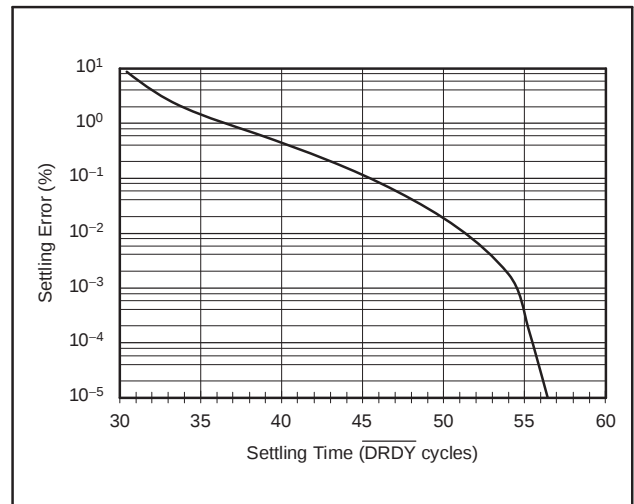


Figure 32. Settling Time

IMPULSE RESPONSE

Figure 33 plots the normalized response for an input applied at $t = 0$, with $\text{MODE} = 00$. The X-axis units of time are $\overline{\text{DRDY}}$ cycles for the ADS1610. As shown in Figure 33, the peak of the impulse takes 30 $\overline{\text{DRDY}}$ cycles to propagate to the output. For $f_{\text{CLK}} = 60\text{MHz}$, a $\overline{\text{DRDY}}$ cycle is $0.1\mu\text{s}$ in duration and the propagation time (or group delay) is $30 \times 0.1\mu\text{s} = 3.0\mu\text{s}$.

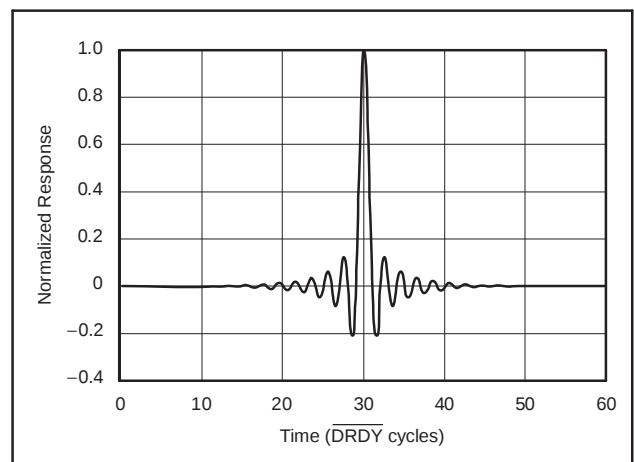


Figure 33. Impulse Response

FREQUENCY RESPONSE

The linear phase FIR digital filter sets the overall frequency response. The decimation rate is set to 6 (MODE = 00) for all the figures shown in this section. [Figure 34](#) shows the frequency response from DC to 30 MHz for $f_{CLK} = 60$ MHz. The frequency response of the ADS1610 filter scales directly with CLK frequency. For example, if the CLK frequency is decreased by half (to 30 MHz), the values on the X-axis in [Figure 34](#) would need to be scaled by half, with the span becoming DC to 15MHz.

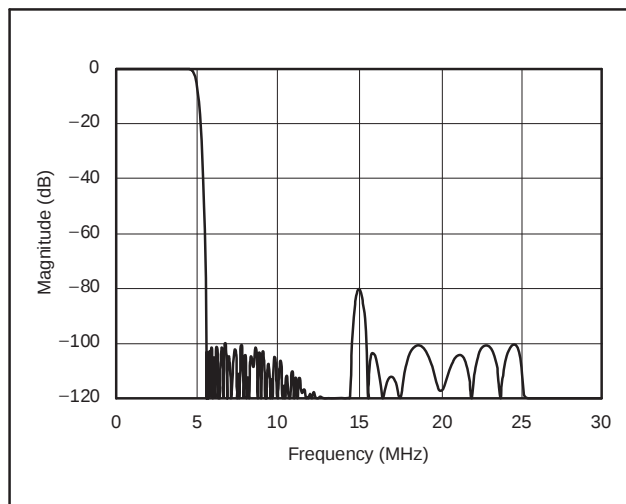


Figure 34. Frequency Response

[Figure 35](#) shows the passband ripple from DC to 4.4MHz ($f_{CLK} = 60$ MHz). [Figure 36](#) shows a closer view of the passband transition by plotting the response from 4.0MHz to 5.0MHz ($f_{CLK} = 60$ MHz).

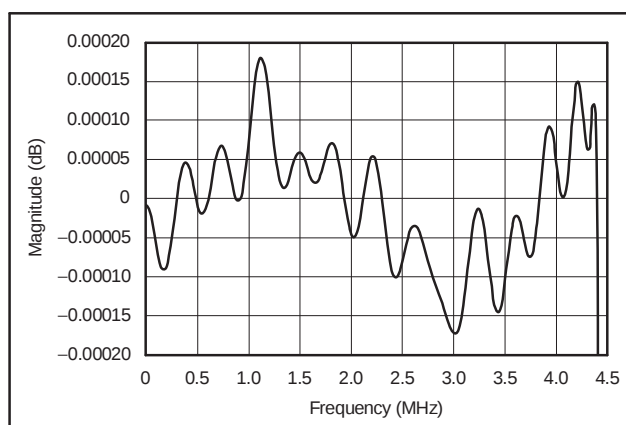


Figure 35. Passband Ripple

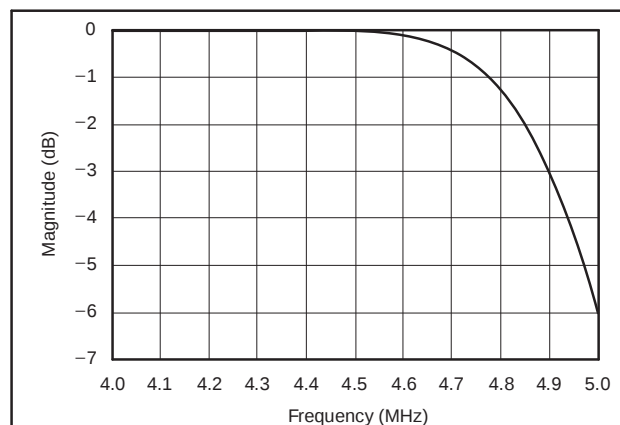


Figure 36. Passband Transition

The overall frequency response repeats at multiples of the CLK frequency. To help illustrate this, [Figure 37](#) shows the response out to 180 MHz ($f_{CLK} = 60$ MHz). Notice how the passband response repeats at 60MHz, 120MHz, and 180MHz; it is important to consider this sequence when there is high-frequency noise present with the signal. The modulator bandwidth extends to 100MHz. High-frequency noise around 60MHz and 120MHz will not be attenuated by either the modulator or the digital filter. This noise will alias back inband and reduce the overall SNR performance unless it is filtered out prior to the ADS1610. To prevent this, place an anti-alias filter in front of the ADS1610 that rolls off before 55MHz.

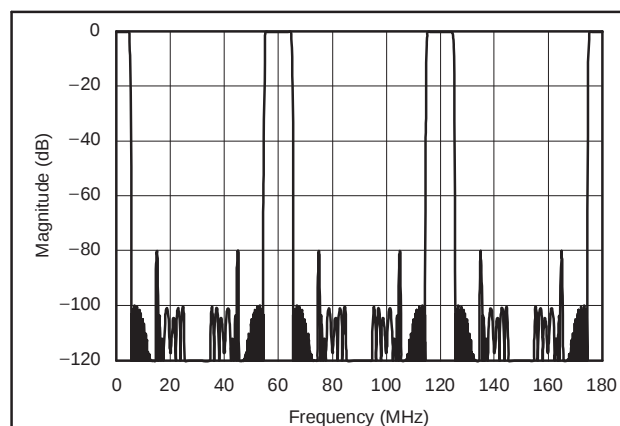


Figure 37. Frequency Response Out to 120MHz

NOISE FLOOR

The ADS1610 is a delta sigma ADC and it uses noise shaping to achieve superior SNR performance. The noise floor of a typical successive approximation (SAR) or a pipeline ADC remains flat until the nyquist frequency occurs. A gain of 3dB in SNR can be achieved by averaging two samples, thereby having a tradeoff between output data rate and achievable SNR. In contrast, the noise floor of the ADS1610 inside the bandwidth of interest is shaped. Hence, the gain in SNR that can be achieved by averaging

two samples is more than 3dB. [Figure 38](#) below shows the typical in-band noise spectral density of the ADS1610. The numbers in the bottom of the figure represent the noise distribution with respect to a full-scale signal in different bandwidths of interest. The shaded area represents the signal bandwidth in the default mode of operation (10MHz output data rate).

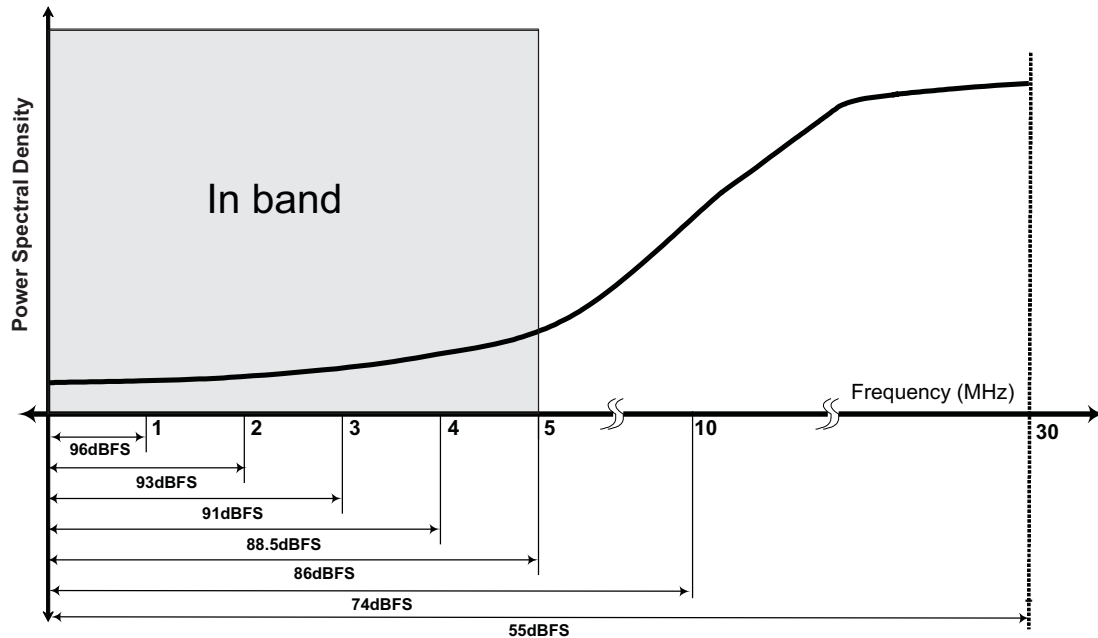


Figure 38. Typical Filter Bypass Mode Noise Spectral Density

By using appropriate filtering the user can achieve a tradeoff between speed and SNR. For ease of use, the ADS1610 provides four filtering modes as explained in the next section. [Figure 39](#) shows a conceptual diagram of the available filtering modes. Custom filtering is achieved by taking the modulator output data and adding a filter externally.

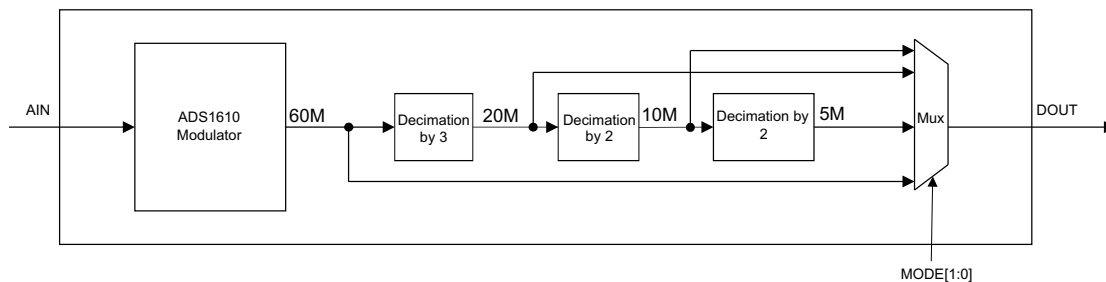


Figure 39. Conceptual Diagram of the ADS1610 Filtering Modes

MODE SELECTION

ADS1610 offers four different modes of operation each with different output data rates. This gives users the flexibility to choose the best output rate for their application. The outputs of all modes are MSB-aligned.

Table 4. Four Modes of Operation⁽¹⁾

Mode 1	Mode 0	OUTPUT RATE	OSR	SNR (TYP)	BITS	SETTLING TIME (DRDY cycles)
0	0	Default 10MHz mode	6	86dBFS	16	55
0	1	20MHz	3	74dBFS	14	25
1	0	5MHz	12	91dBFS	16	55
1	1	60MHz bypass mode	1	55dBFS	12	NA

(1) There is a pull-down resistor of 170kΩ on both mode pins; however, it is recommended that this pin be reduced to either high or low.

20MHz MODE

In this mode, the oversampling ratio is three. Decreasing the OSR from 6 to 3 doubles the data rate, at the same time the performance is reduced from 16 bits to 14 bits. Note that all 16 bits of DOUT remain active in this mode. For $f_{\text{clk}} = 60\text{MHz}$, the data rate is 20MSPS. In addition, the group delay becomes 1 μs or 13 $\overline{\text{DRDY}}$ cycles. In this mode the noise increases. Typical SNR performance degrades by 14dB. THD remains approximately the same.

5MHz MODE

In this mode the OSR is 12 for $f_{\text{clk}} = 60\text{MHz}$ and the data rate is 5MSPS. Typical SNR performance increases by 4dB. THD remains approximately the same.

60MHz MODE

In this mode, decimation filters are bypassed. This data output can be filtered externally by the user. For $f_{\text{clk}} = 60\text{MHz}$, the data rate is 60MSPS.

ANALOG POWER DISSIPATION

An external resistor connected between the RBIAS pin and the analog ground sets the analog current level, as shown in Figure 40. The current is inversely proportional to the resistor value. Table 5 shows the recommended values of RBIAS for different CLK frequencies. Notice that the analog current can be reduced when using a slower frequency CLK input because the modulator has more time to settle. Avoid adding any capacitance in parallel to RBIAS, since this will interfere with the internal circuitry used to set the biasing.

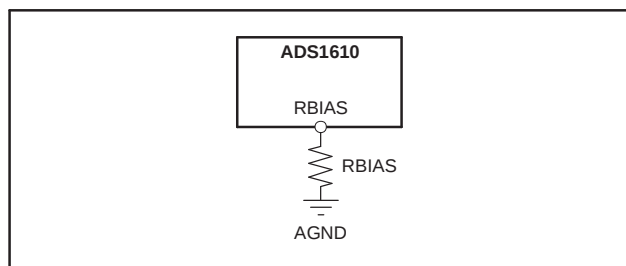


Figure 40. External Resistor Used to Set Analog Power Dissipation

Table 5. Recommended RBIAS Resistor Values for Different CLK Frequencies

f_{CLK}	DATA RATE	RBIAS	TYPICAL POWER DISSIPATION
42MHz	7MHz	45kΩ	550mW
48MHz	8MHz	37kΩ	640mW
54MHz	9MHz	31kΩ	720mW
60MHz	10MHz	19kΩ	960mW

POWER-DOWN ($\overline{\text{PD}}$)

When not in use, the ADS1610 can be powered down by taking the $\overline{\text{PD}}$ pin low. There is an internal pull-up resistor of 170kΩ on the $\overline{\text{PD}}$ pin, but it is recommended that this pin be connected to DVDD if not used. Once the $\overline{\text{PD}}$ pin is pulled high, allow at least t_{11} (see Timing Specification Table) $\overline{\text{DRDY}}$ cycles for the modulator and the digital filter to settle before retrieving data.

POWER SUPPLIES

Two supplies are used on the ADS1610: analog (AVDD), and digital (DVDD). Each supply (other than DVDD pins 49 and 50) must be suitably bypassed to achieve the best performance. It is recommended that a 1μF and 0.1μF ceramic capacitor be placed as close to each supply pin as possible. Connect each supply-pin bypass capacitor to the associated ground, as shown in Figure 41. Each main supply bus should also be bypassed with a bank of capacitors from 47μF to 0.1μF, as shown in Figure 41.

For optimum performance, insert a 10Ω resistor in series with the AVDD2 supply (pin 58); the modulator clocking circuitry. This resistor decouples switching.

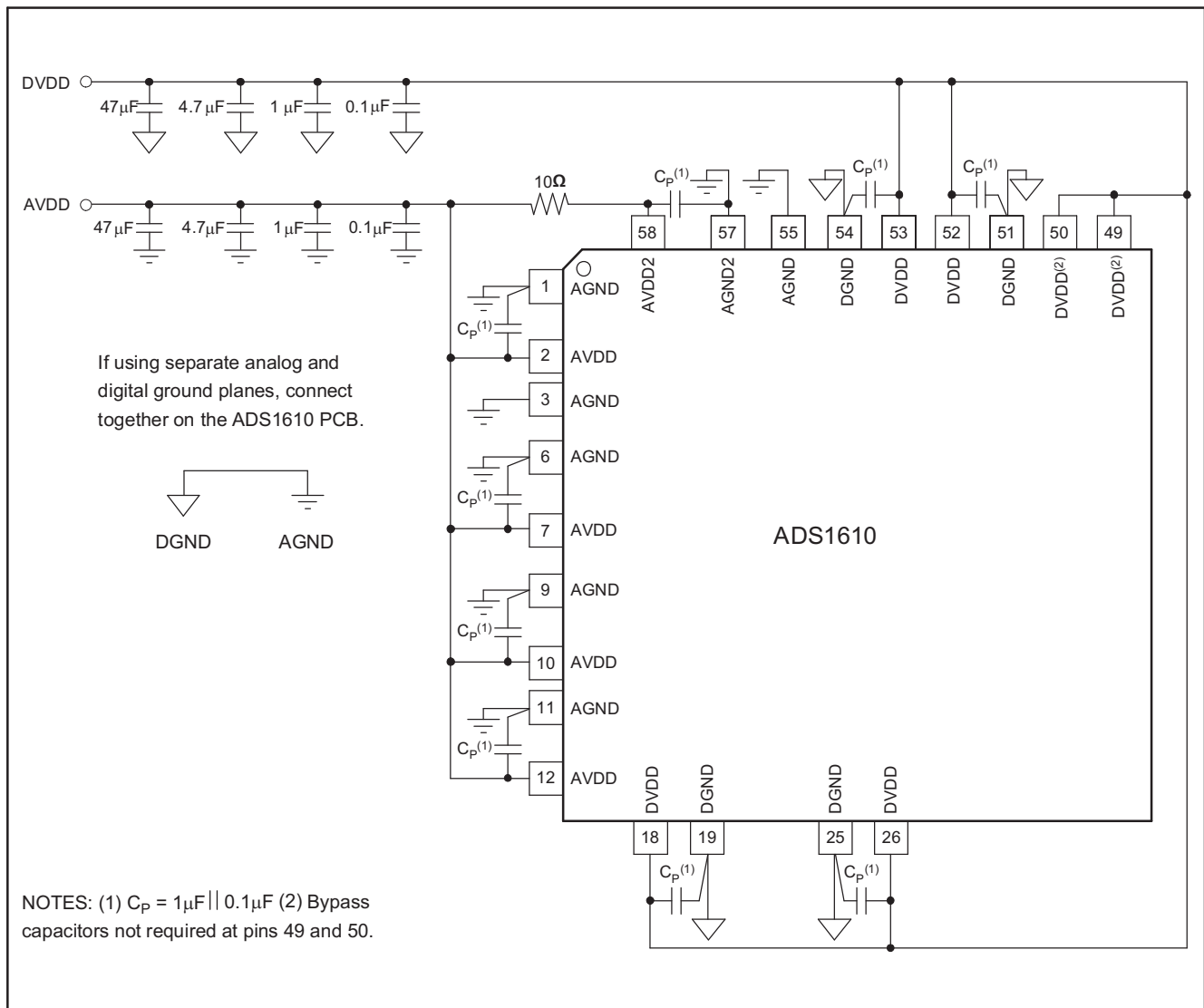


Figure 41. Recommended Power-Supply Bypassing

LAYOUT ISSUES

The ADS1610 is a very high-speed, high-resolution data converter. In order to achieve the maximum performance, careful attention must be given to the printed circuit board (PCB) layout. Use good high-speed techniques for all circuitry. Critical capacitors should be placed close to pins as possible. These include capacitors directly connected to the analog and reference inputs and the power supplies. Make sure to also properly bypass all circuitry driving the inputs and references.

Two approaches can be used for the ground planes: either a single common plane; or two separate

planes, one for the analog grounds and one for the digital grounds. When using only one common plane, isolate the flow of current on AGND2 (pin 57) from pin 1; use breaks on the ground plane to accomplish this. AGND2 carries the switching current from the analog clocking for the modulator and can corrupt the quiet analog ground on pin 1. When using two planes, it is recommended that they be tied together right at the PCB. Do not try to connect the ground planes together after running separately through edge connectors or cables as this reduces performance and increases the likelihood of latch-up.

In general, keep the resistances used in the driving circuits for the inputs and reference low to prevent excess thermal noise from degrading overall performance. Avoid having the ADS1610 digital outputs drive heavy loads. Buffers on the outputs are recommended unless the ADS1610 is connected directly to a DSP or controller situated nearby. Additionally, make sure the digital inputs are driven with clean signals as ringing on the inputs can introduce noise.

The ADS1610 uses TI PowerPAD™ technology. The PowerPAD is physically connected to the substrate of the silicon inside the package and must be soldered to the analog ground plane on the PCB using the exposed metal pad underneath the package for proper heat dissipation. See application report [SLMA002](#), located at www.ti.com, for more details on the PowerPAD package.

APPLICATION INFORMATION

INTERFACING THE ADS1610 TO THE TMS320C6000

Figure 42 illustrates how to directly connect the ADS1610 to the TMS320C6000 DSP. The processor controls the reading using output $\overline{ARE}$. The ADS1610 is selected using the DSP control output, $\overline{CE2}$. The ADS1610 16-bit data output bus is directly connected to the TMS320C6000 data bus. The data ready output ($\overline{DRDY}$) from the ADS1610 drives interrupt $\overline{EXT_INT7}$ on the TMS320C6000.

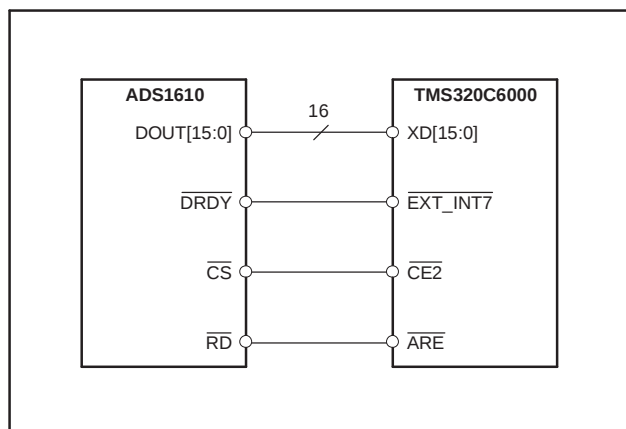


Figure 42. ADS1610 – TMS320C6000 Interface Connection

INTERFACING THE ADS1610 TO THE TMS320C5400

Figure 43 illustrates how to connect the ADS1610 to the TMS320C5400 DSP. The processor controls the reading using the outputs $\overline{R/W}$ and $\overline{IS}$. The I/O space-select signal ($\overline{IS}$) is optional and is used to prevent the ADS1610 $\overline{RD}$ input from being strobed when the DSP is accessing other external memory

spaces (address or data). This can help reduce the possibility of digital noise coupling into the ADS1610. When not using this signal, replace NAND gate U1 with an inverter between $\overline{R/W}$ and $\overline{RD}$. Two signals, $\overline{IOSTRB}$ and A15, combine using NAND gate U2 to select the ADS1610. If there are no additional devices connected to the TMS320C5400 I/O space, U2 can be eliminated. Simply connect $\overline{IOSTRB}$ directly to $\overline{CS}$. The ADS1610 16-bit data output bus is directly connected to the TMS320C5400 data bus. The data ready output ($\overline{DRDY}$) from the ADS1610 drives interrupt $\overline{INT3}$ on the TMS320C5400.

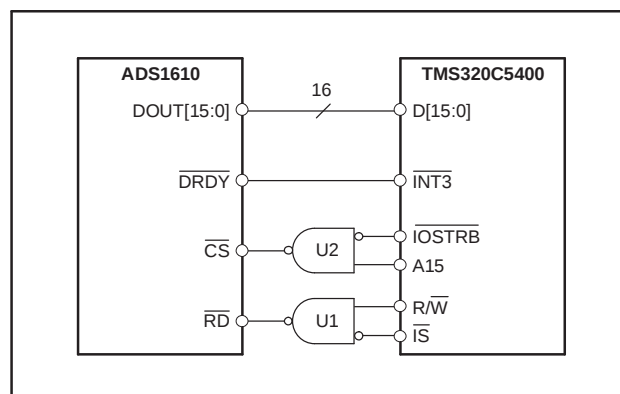


Figure 43. ADS1610 – TMS320C5400 Interface Connection

Code Composer Studio, available from TI, provides support for interfacing TI DSPs through a collection of data converter plug-ins. Check the TI website, located at www.ti.com/sc/dcplug-in, for the latest information on ADS1610 support.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
ADS1610IPAPR	NRND	Production	HTQFP (PAP) 64	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1610I
ADS1610IPAPR.B	NRND	Production	HTQFP (PAP) 64	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1610I
ADS1610IPAPT	NRND	Production	HTQFP (PAP) 64	250 SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1610I
ADS1610IPAPT.B	NRND	Production	HTQFP (PAP) 64	250 SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1610I

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS1610IPAPR	HTQFP	PAP	64	1000	330.0	24.4	13.0	13.0	1.5	16.0	24.0	Q2
ADS1610IPAPT	HTQFP	PAP	64	250	180.0	24.4	13.0	13.0	1.5	16.0	24.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADS1610IPAPR	HTQFP	PAP	64	1000	350.0	350.0	43.0
ADS1610IPAPT	HTQFP	PAP	64	250	213.0	191.0	55.0

GENERIC PACKAGE VIEW

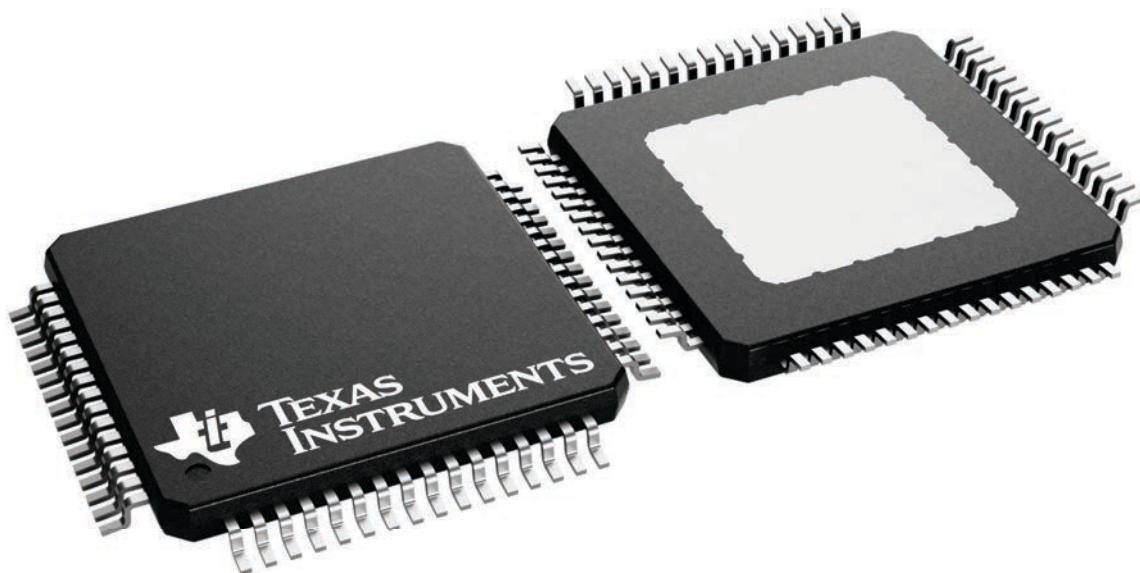
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HTQFP - 1.2 mm max height

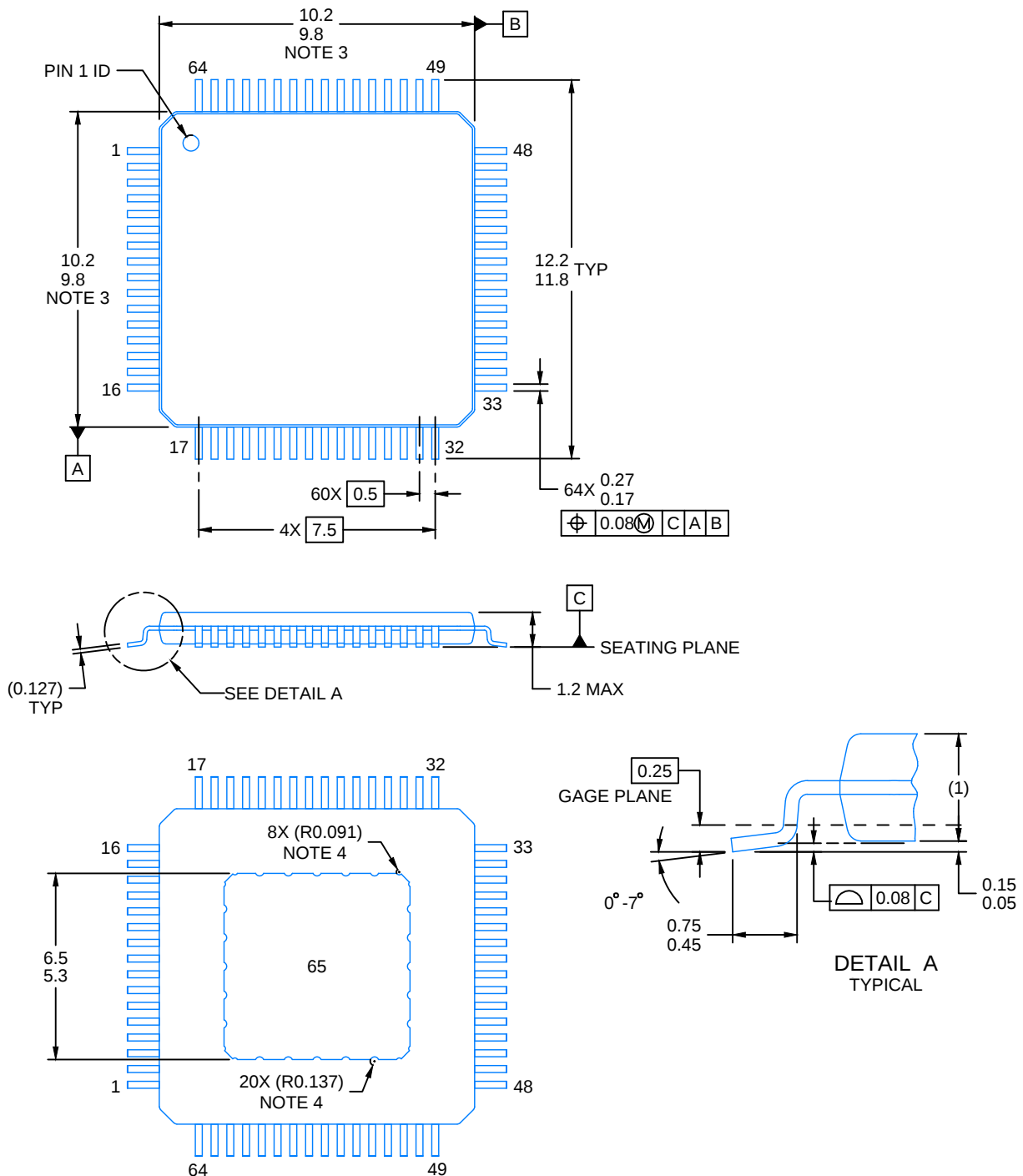
10 x 10, 0.5 mm pitch

QUAD FLATPACK

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4226442/A



4226412/A 11/2020

NOTES:

PowerPAD is a trademark of Texas Instruments.

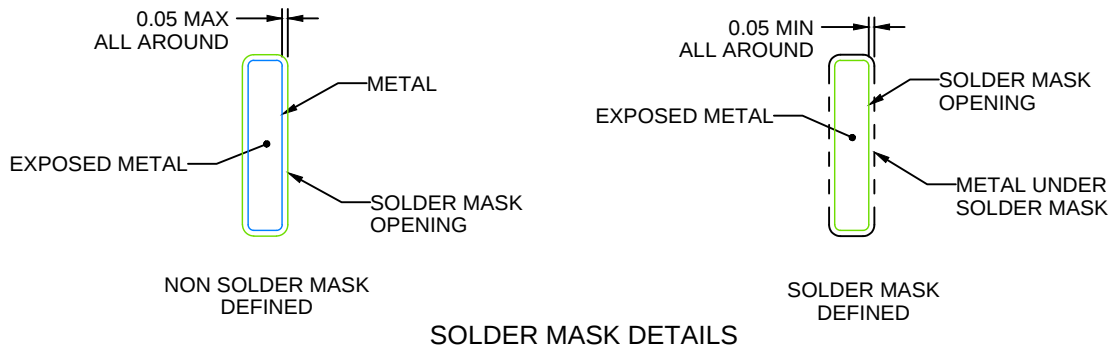
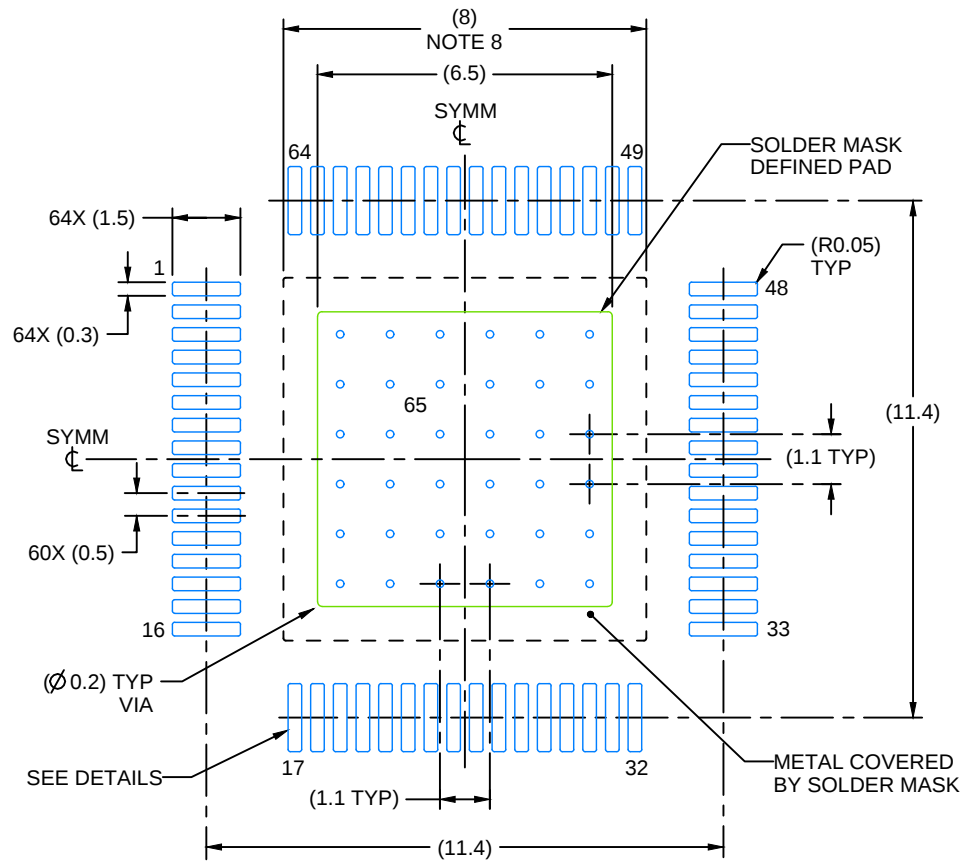
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs.
4. Strap features may not be present.
5. Reference JEDEC registration MS-026.

EXAMPLE BOARD LAYOUT

PAP0064F

PowerPAD™ TQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



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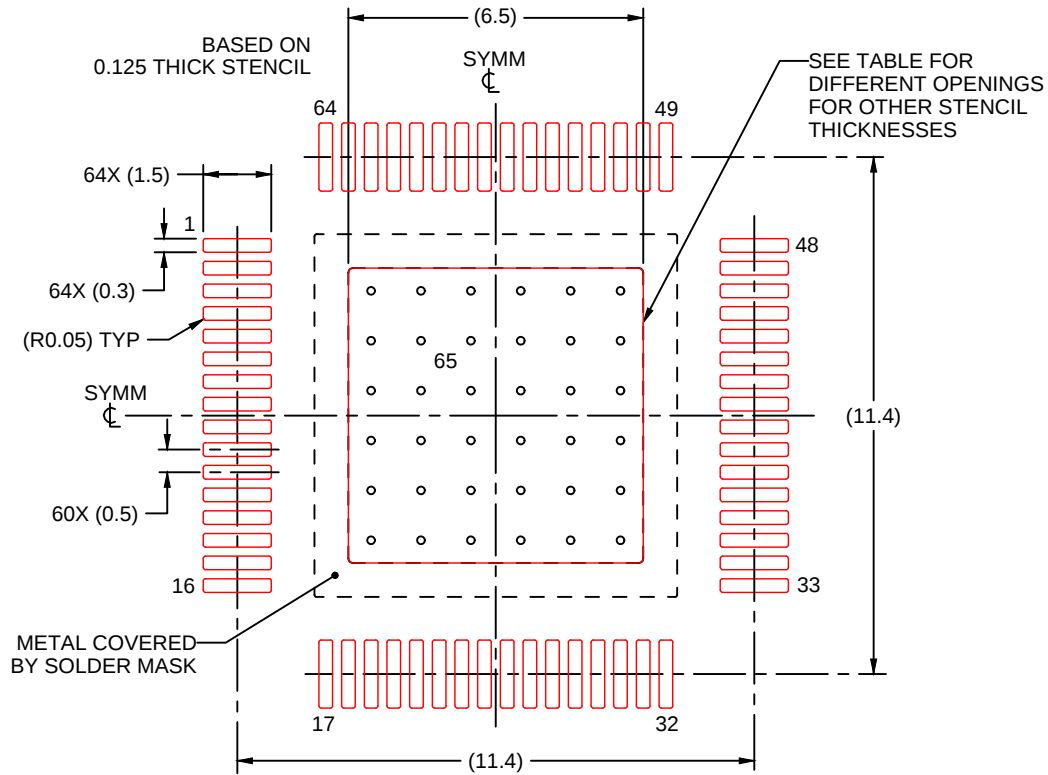
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. This package is designed to be soldered to a thermal pad on the board. See technical brief, Powerpad thermally enhanced package, Texas Instruments Literature No. SLMA002 (www.ti.com/lit/slma002) and SLMA004 (www.ti.com/lit/slma004).
9. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.
10. Size of metal pad may vary due to creepage requirement.

PAP0064F

PowerPAD™ TQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



SOLDER PASTE EXAMPLE
EXPOSED PAD
100% PRINTED SOLDER COVERAGE BY AREA
SCALE:6X

STENCIL THICKNESS	SOLDER STENCIL OPENING
0.1	7.27 X 7.27
0.125	6.5 X 6.5 (SHOWN)
0.15	5.93 X 5.93
0.175	5.49 X 5.49

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NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

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